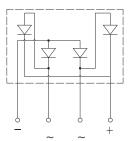
Low VF Bridge Rectifiers



Features

UL recognition, file #E230084 based on silicon planar process Ideal for printed circuit boards High surge current capability Low VF Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

Mechanical Data

Package: GBU Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102 Polarity: As marked on body

Maximum Ratings (Ta=25 Unless otherwise specified

PARAMETER		SYMBOL	UNIT	GBUU2508	
Device marking code				GBUU2508	
Maximum Repetitive Peak Reverse Voltage		VRRM	V	800	
Maximum RMS Voltage		VRMS	V	560	
Maximum DC blocking Vo	oltage	VDC	V	800	
Average rectified output	With heatsink Tc =110	IO	A	25.0	
current @60Hz sine wave, R-load	Without heatsink Ta =25			4.0	
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25		IFSM	A	360	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25				700	
Current squared time @1ms_t_8.3ms_Tj=25, Rating of per diode		l ² t	A ² S	538	
Storage temperature		Tstg		-55 ~ +150	
Junction temperature		Тј		-55 ~ +150	
Dielectric strength @ Terminals to case, AC 1 minute		Vdis	КV	2.5	
Mounting torque @Recommend torque 5kg cm		Tor	kg cm	8	

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Electrical Characteristics T_a=25 Unless otherwise specified

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	Min	Тур	Max
Instantaneous forward voltage drop per diode	VF	V	IFM=12.5A	0.80	0.86	0.92
DC reverse current at rated DC blocking voltage per diode	IR	μΑ	Tj =25	-	0.005	5
			Tj =125	-	-	50
Junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	80	164	330

Thermal Characteristics Ta=25 Unless otherwise specified

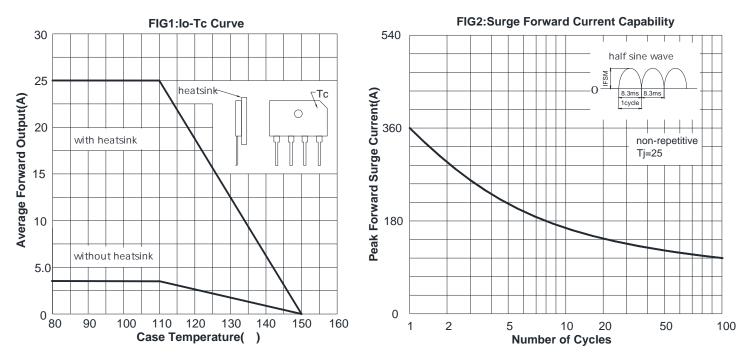
PARAMETER		SYMBOL	UNIT	GBUU2508
	Between junction and ambient, Without heatsink	R J-A		25.0
Typical Thermal Resistance	Between junction and lead, With heatsink	R J-L	/W	4.0
	Between junction and case, With heatsink	R J-C		1.4

Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

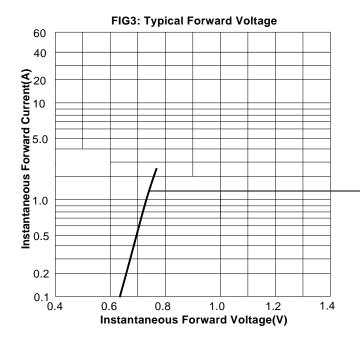
Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GBUU2508	B1	Approximate 3.96	20	1000	2000	TUBE

Characteristics (Typical)



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Outline Dimensions

GBU					
Dim	Min	Max			
А	21.80	22.30			
В	18.30	18.80			
С	17.50	18.00			
D	3.30	3.90			
E	7.10	7.50			
F	5.50	5.90			
G	1.91	2.54			
Н	2.06	2.54			
I	1.02	1.27			
J	4.83	5.33			
K	3.30	3.56			
L	2.40	2.66			
М	0.46	0.56			

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GBUU2508

Disclaimer

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The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

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